

IGBT

NGTB75N65FL2WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 μs Short-Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

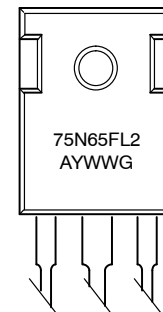
| Rating | Symbol | Value | Unit |
|--|-----------|-------------|-------------|
| Collector-emitter Voltage | V_{CES} | 650 | V |
| Collector Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$ | I_C | 100 75 | A |
| Diode Forward Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$ | I_F | 100 75 | A |
| Diode Pulsed Current T_{PULSE} Limited by T_J Max | I_{FM} | 200 | A |
| Pulsed Collector Current, T_{pulse} Limited by T_{Jmax} | I_{CM} | 200 | A |
| Short-circuit Withstand Time $V_{GE} = 15 V, V_{CE} = 400 V,$ $T_J \leq +150^{\circ}C$ | t_{SC} | 5 | μs |
| Gate-emitter Voltage | V_{GE} | ± 20 | V |
| Transient Gate-emitter Voltage ($T_{PULSE} = 5 \mu s, D < 0.10$) | | ± 30 | V |
| Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$ | P_D | 595 265 | W |
| Operating Junction Temperature Range | T_J | -55 to +175 | $^{\circ}C$ |
| Storage Temperature Range | T_{stg} | -55 to +175 | $^{\circ}C$ |
| Lead temperature for soldering, 1/8" from case for 5 seconds | T_{SLD} | 260 | $^{\circ}C$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

75 A, 650 V
 $V_{CEsat} = 1.70 V$
 $E_{off} = 1.0 mJ$



MARKING DIAGRAM



75N65FL2 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

| Device | Package | Shipping |
|----------------|---------------------|-----------------|
| NGTB75N65FL2WG | TO-247 (Pb-Free) | 30 Units / Rail |

NGTB75N65FL2WG

THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|--|-----------------|-------|-----------------------------|
| Thermal resistance junction-to-case, for IGBT | $R_{\theta JC}$ | 0.28 | $^{\circ}\text{C}/\text{W}$ |
| Thermal resistance junction-to-case, for Diode | $R_{\theta JC}$ | 0.62 | $^{\circ}\text{C}/\text{W}$ |
| Thermal resistance junction-to-ambient | $R_{\theta JA}$ | 40 | $^{\circ}\text{C}/\text{W}$ |

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}\text{C}$ unless otherwise specified)

| Parameter | Test Conditions | Symbol | Min | Typ | Max | Unit |
|-----------|-----------------|--------|-----|-----|-----|------|
|-----------|-----------------|--------|-----|-----|-----|------|

STATIC CHARACTERISTIC

| | | | | | | |
|---|---|---------------|-----------|--------------|------------|----|
| Collector-emitter breakdown voltage, gate-emitter short-circuited | $V_{GE} = 0\text{ V}, I_C = 500\ \mu\text{A}$ | $V_{(BR)CES}$ | 650 | - | - | V |
| Collector-emitter saturation voltage | $V_{GE} = 15\text{ V}, I_C = 75\text{ A}$ $V_{GE} = 15\text{ V}, I_C = 75\text{ A}, T_J = 175^{\circ}\text{C}$ | V_{CEsat} | 1.50 - | 1.75 2.30 | 2.00 - | V |
| Gate-emitter threshold voltage | $V_{GE} = V_{CE}, I_C = 350\ \mu\text{A}$ | $V_{GE(th)}$ | 4.5 | 5.5 | 6.5 | V |
| Collector-emitter cut-off current, gate-emitter short-circuited | $V_{GE} = 0\text{ V}, V_{CE} = 650\text{ V}$ $V_{GE} = 0\text{ V}, V_{CE} = 650\text{ V}, T_J = 175^{\circ}\text{C}$ | I_{CES} | - - | - - | 0.1 4.0 | mA |
| Gate leakage current, collector-emitter short-circuited | $V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}$ | I_{GES} | - | - | 200 | nA |

DYNAMIC CHARACTERISTIC

| | | | | | | |
|------------------------------|--|-----------|---|------|---|----|
| Input capacitance | $V_{CE} = 20\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$ | C_{ies} | - | 7500 | - | pF |
| Output capacitance | | C_{oes} | - | 300 | - | |
| Reverse transfer capacitance | | C_{res} | - | 190 | - | |
| Gate charge total | $V_{CE} = 480\text{ V}, I_C = 50\text{ A}, V_{GE} = 15\text{ V}$ | Q_g | - | 310 | - | nC |
| Gate to emitter charge | | Q_{ge} | - | 60 | - | |
| Gate to collector charge | | Q_{gc} | - | 150 | - | |

SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

| | | | | | | | |
|-------------------------|--|--------------|-------|-----|-----|----|----|
| Turn-on delay time | $T_J = 25^{\circ}\text{C}$ $V_{CC} = 400\text{ V}, I_C = 75\text{ A}$ $R_g = 10\ \Omega$ $V_{GE} = 0\text{ V}/15\text{ V}$ | $t_{d(on)}$ | - | 110 | - | ns | |
| Rise time | | t_r | - | 48 | - | | |
| Turn-off delay time | | $t_{d(off)}$ | - | 270 | - | | |
| Fall time | | | t_f | - | 70 | - | mJ |
| Turn-on switching loss | | E_{on} | - | 2.2 | - | | |
| Turn-off switching loss | | E_{off} | - | 1.1 | - | | |
| Total switching loss | | E_{ts} | - | 3.3 | - | | |
| Turn-on delay time | $T_J = 150^{\circ}\text{C}$ $V_{CC} = 400\text{ V}, I_C = 75\text{ A}$ $R_g = 10\ \Omega$ $V_{GE} = 0\text{ V}/15\text{ V}$ | $t_{d(on)}$ | - | 100 | - | ns | |
| Rise time | | t_r | - | 50 | - | | |
| Turn-off delay time | | $t_{d(off)}$ | - | 280 | - | | |
| Fall time | | | t_f | - | 100 | - | mJ |
| Turn-on switching loss | | E_{on} | - | 2.8 | - | | |
| Turn-off switching loss | | E_{off} | - | 1.6 | - | | |
| Total switching loss | | E_{ts} | - | 4.4 | - | | |

DIODE CHARACTERISTIC

| | | | | | | |
|--------------------------|---|-----------|-----------|--------------|-----------|---------------|
| Forward voltage | $V_{GE} = 0\text{ V}, I_F = 75\text{ A}$ $V_{GE} = 0\text{ V}, I_F = 75\text{ A}, T_J = 175^{\circ}\text{C}$ | V_F | 1.50 - | 2.20 2.40 | 2.90 - | V |
| Reverse recovery time | $T_J = 25^{\circ}\text{C}$ $I_F = 75\text{ A}, V_R = 400\text{ V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ | t_{rr} | - | 80 | - | ns |
| Reverse recovery charge | | Q_{rr} | - | 0.40 | - | μC |
| Reverse recovery current | | I_{rrm} | - | 8 | - | A |
| Reverse recovery time | $T_J = 175^{\circ}\text{C}$ $I_F = 75\text{ A}, V_R = 400\text{ V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ | t_{rr} | - | 143 | - | ns |
| Reverse recovery charge | | Q_{rr} | - | 1.45 | - | μC |
| Reverse recovery current | | I_{rrm} | - | 16 | - | A |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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TYPICAL CHARACTERISTICS

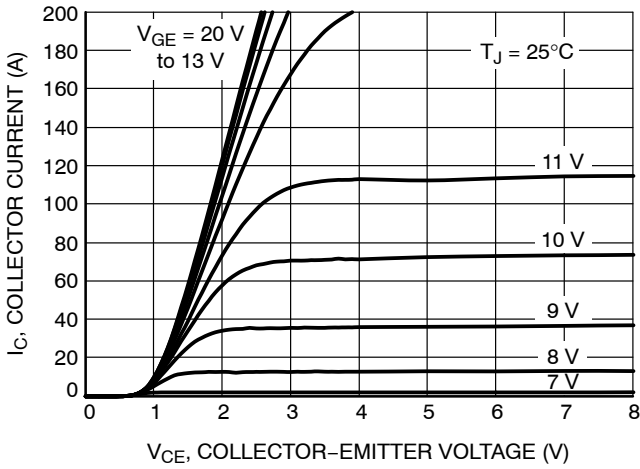


Figure 1. Output Characteristics

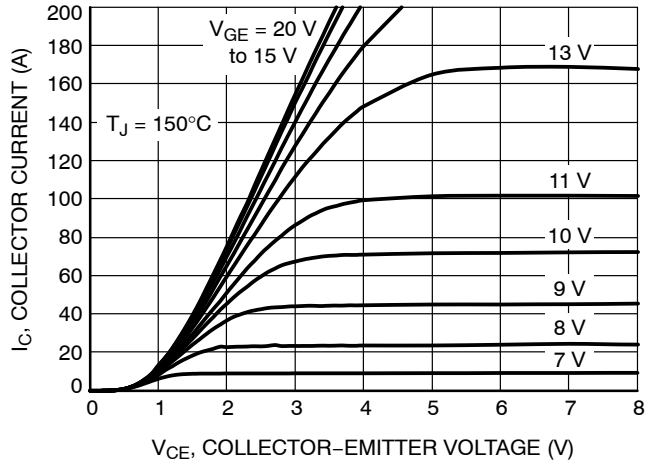


Figure 2. Output Characteristics

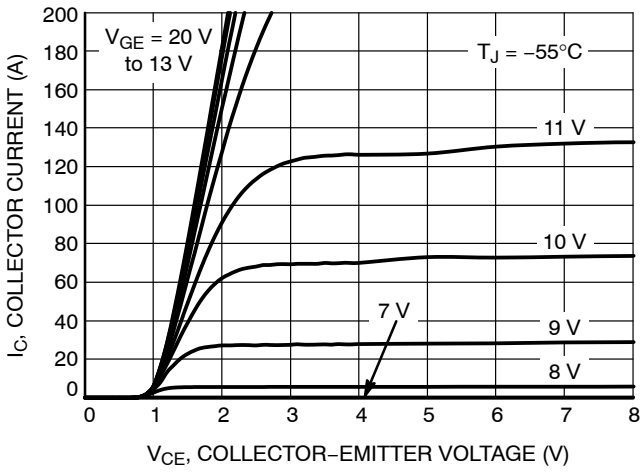


Figure 3. Output Characteristics

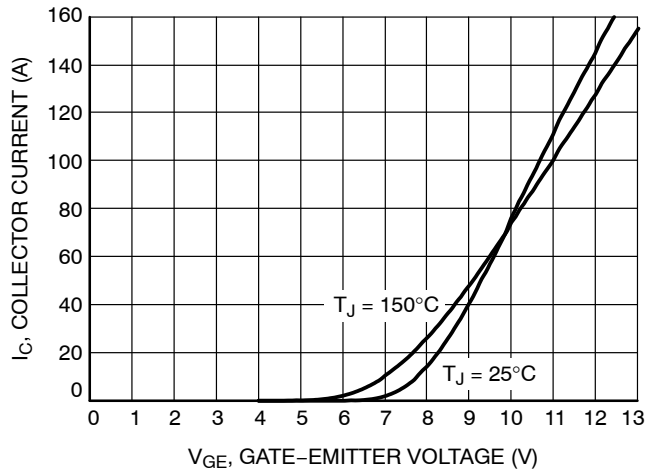


Figure 4. Typical Transfer Characteristics

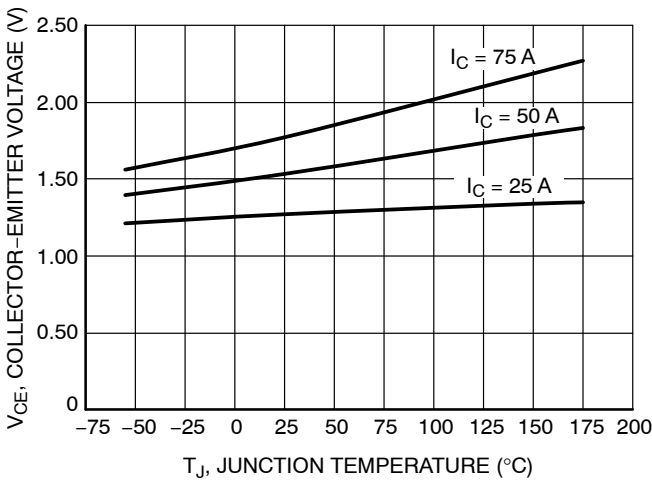


Figure 5. $V_{CE(sat)}$ vs. T_J

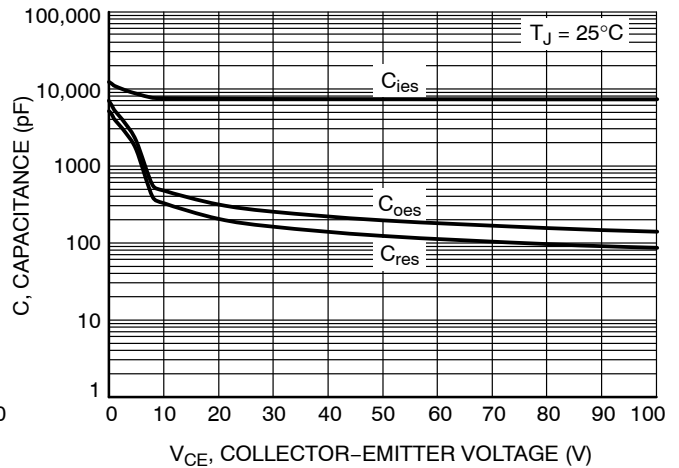


Figure 6. Typical Capacitance

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TYPICAL CHARACTERISTICS

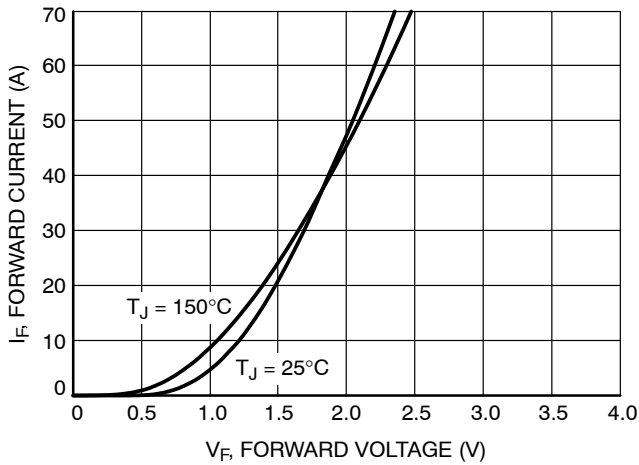


Figure 7. Diode Forward Characteristics

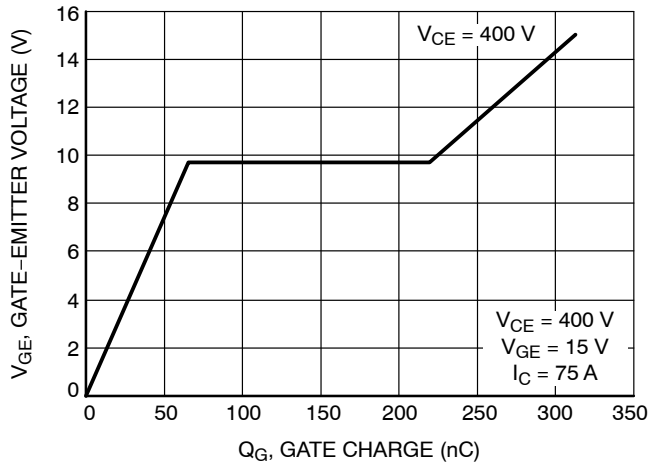


Figure 8. Typical Gate Charge

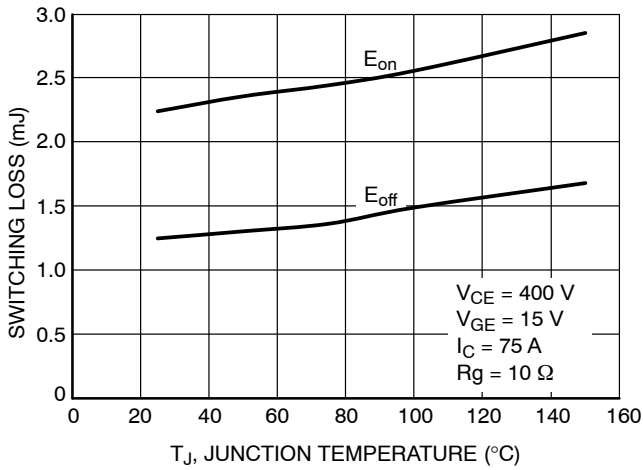


Figure 9. Switching Loss vs. Temperature

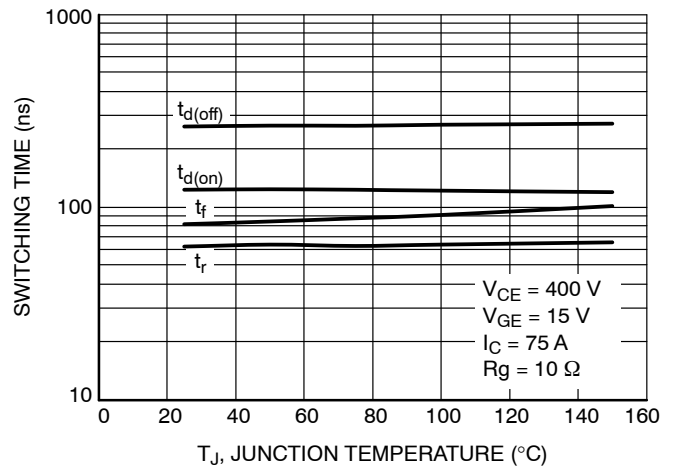


Figure 10. Switching Time vs. Temperature

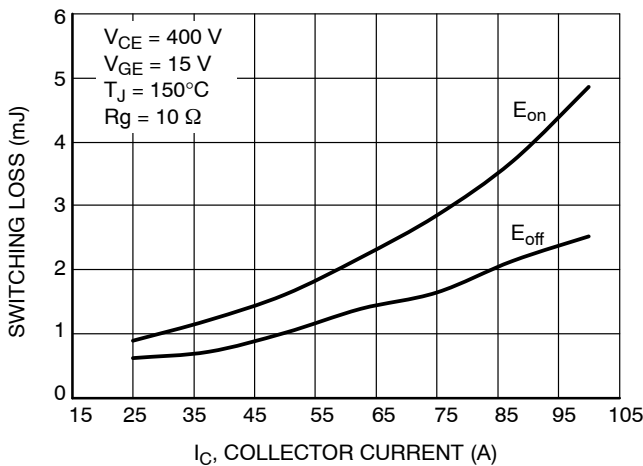


Figure 11. Switching Loss vs. I_C

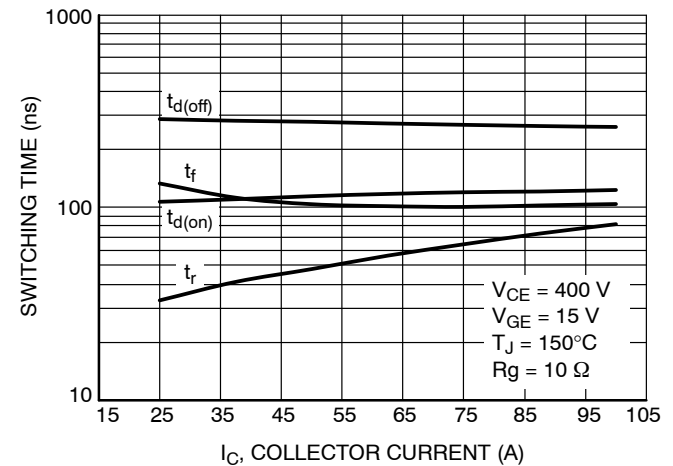


Figure 12. Switching Time vs. I_C

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TYPICAL CHARACTERISTICS

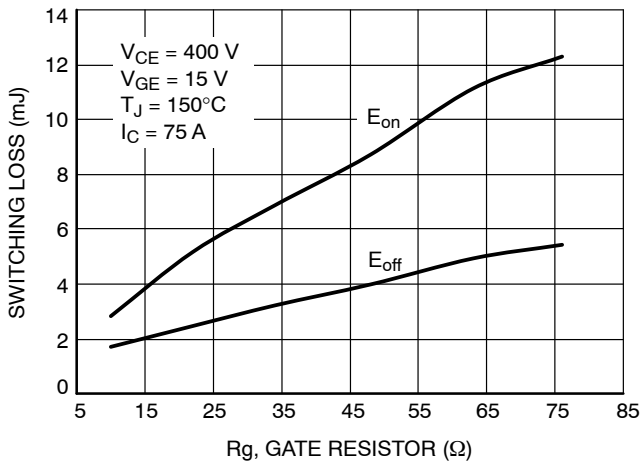


Figure 13. Switching Loss vs. Rg

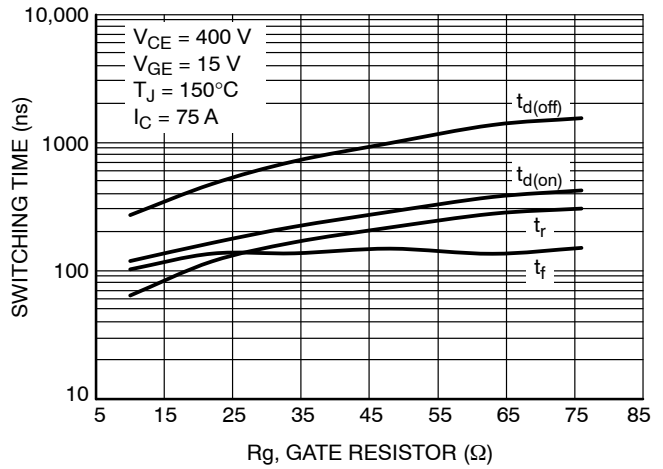


Figure 14. Switching Time vs. Rg

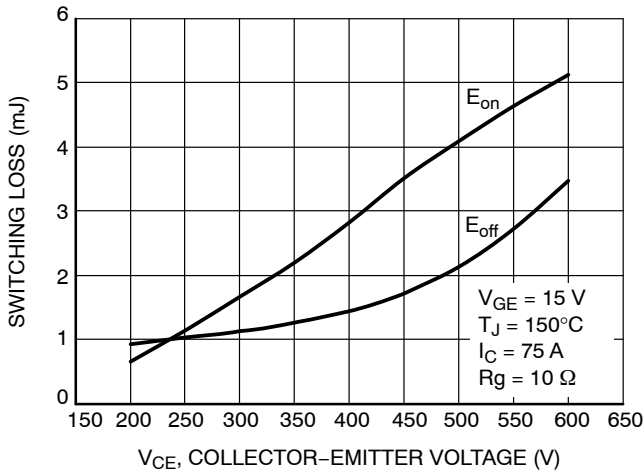


Figure 15. Switching Loss vs. V_{CE}

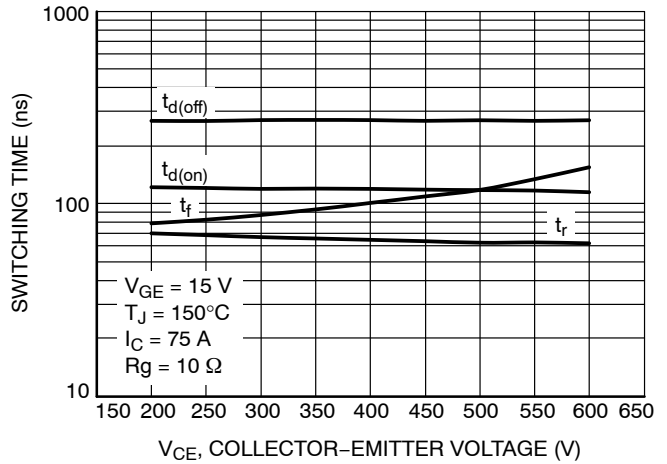


Figure 16. Switching Time vs. V_{CE}

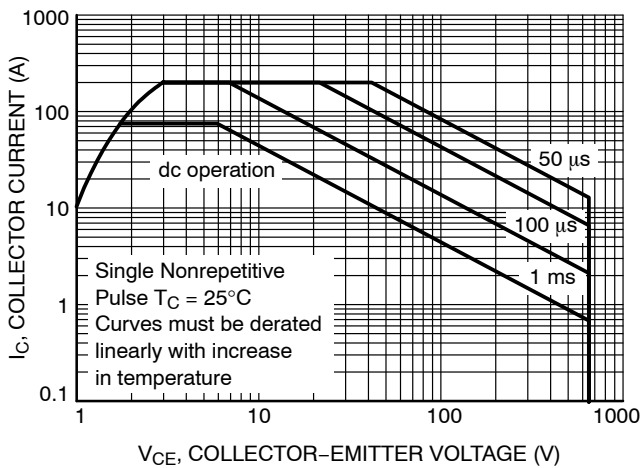


Figure 17. Safe Operating Area

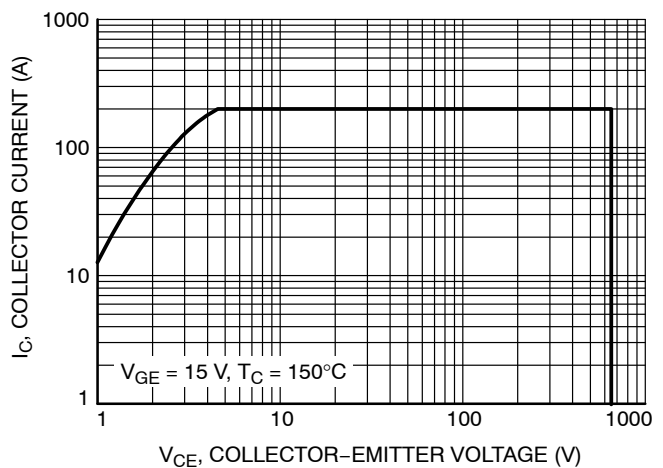


Figure 18. Reverse Bias Safe Operating Area

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TYPICAL CHARACTERISTICS

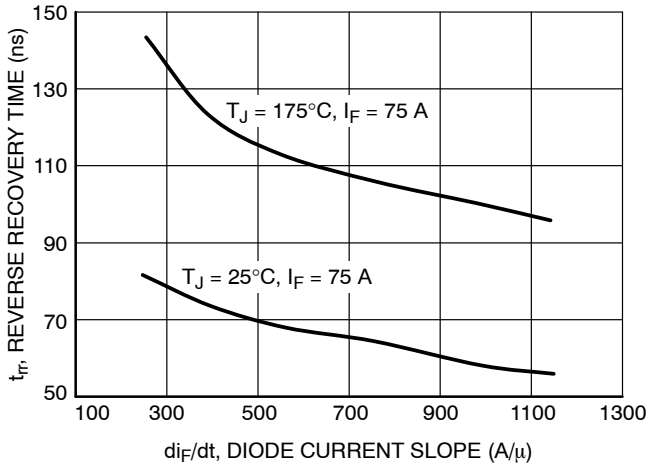


Figure 19. t_{rr} vs. di_F/dt ($V_R = 400\text{ V}$)

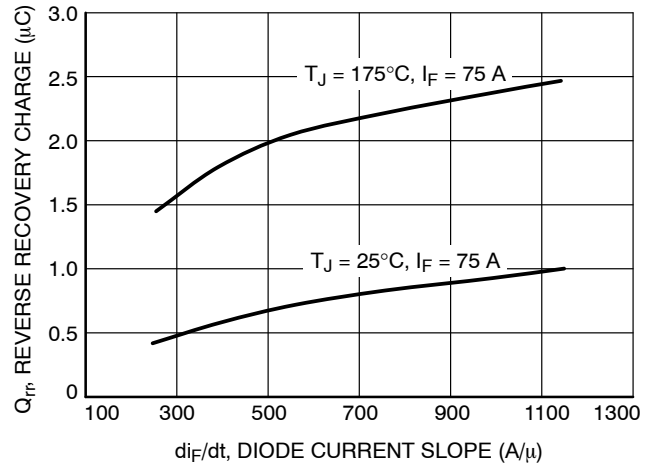


Figure 20. Q_{rr} vs. di_F/dt ($V_R = 400\text{ V}$)

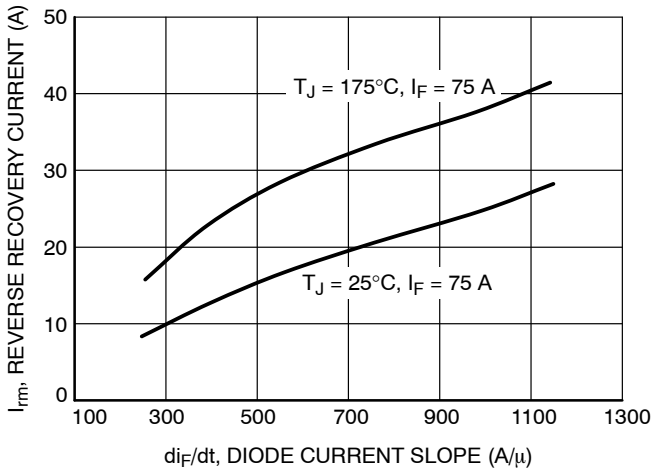


Figure 21. I_{rm} vs. di_F/dt ($V_R = 400\text{ V}$)

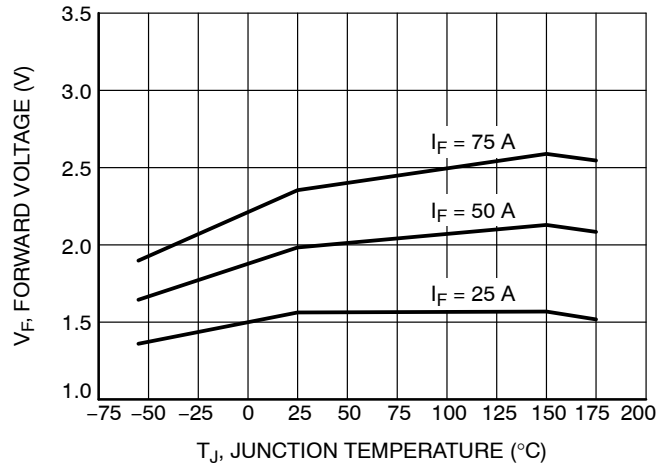


Figure 22. V_F vs. T_J

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TYPICAL CHARACTERISTICS

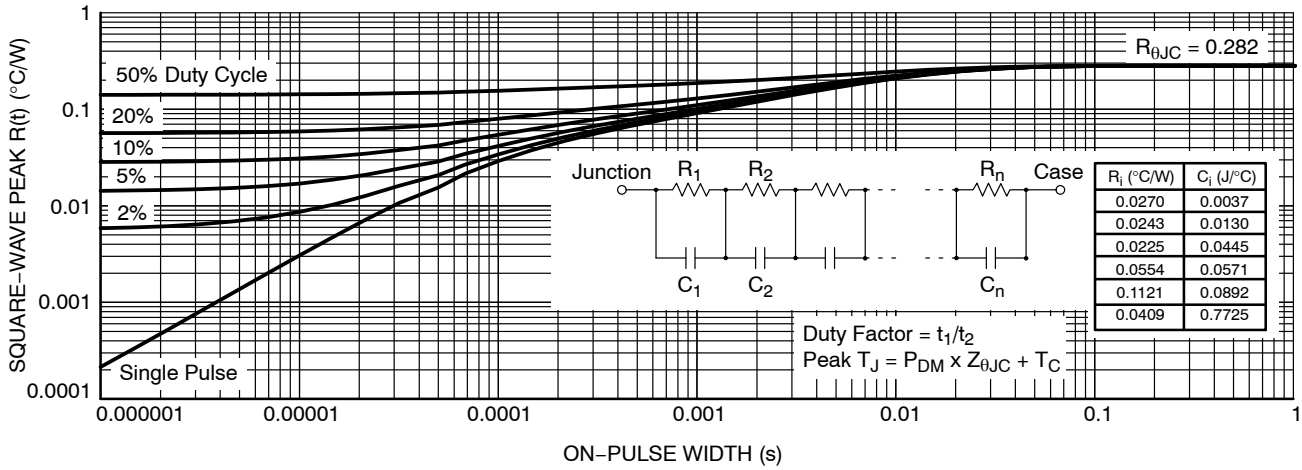


Figure 23. IGBT Transient Thermal Impedance

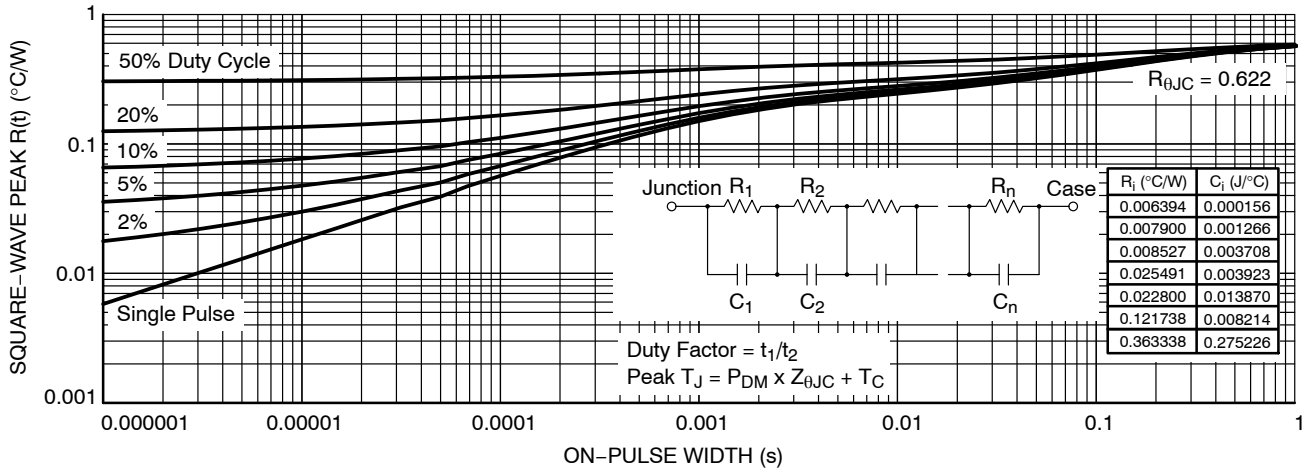


Figure 24. Diode Transient Thermal Impedance

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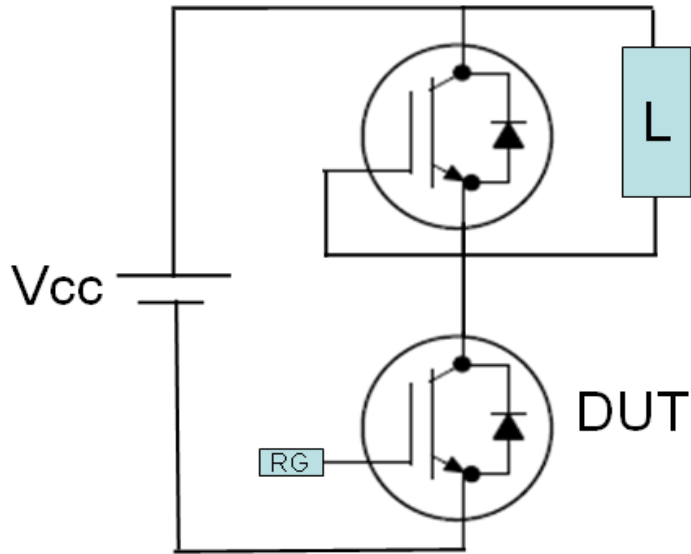


Figure 25. Test Circuit for Switching Characteristics

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Figure 26. Definition of Turn On Waveform



Figure 27. Definition of Turn Off Waveform

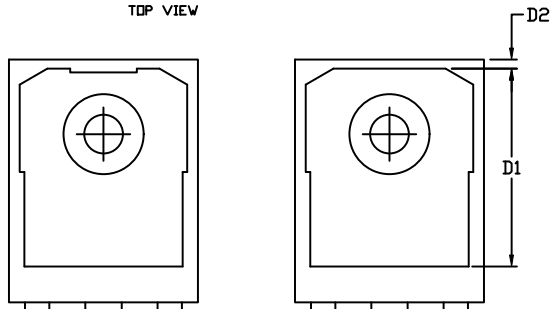
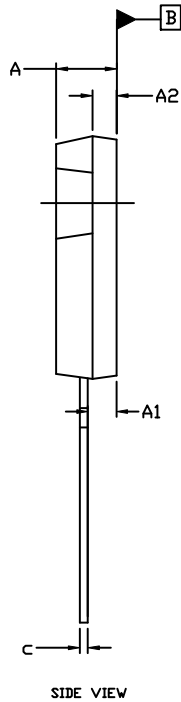
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

ON Semiconductor®



TO-247
CASE 340AM
ISSUE C

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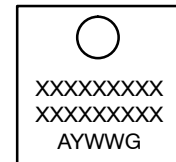
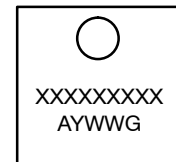
NOTE 4 HEATSINK SHAPES

NOTES:

1. DIMENSIONING AND TOLERANCE AS PER ASME Y14.5M, 2009.
2. ALL DIMENSION ARE IN MILLIMETERS.
3. SLOT REQUIRED, NOTCH MAY BE ROUNDED.
4. OPTIONAL BACK SIDE HEATSINK SHAPE.
5. DIMENSIONS ARE EXCLUSIVE OF BURRS AND MOLD FLASH. DIMENSIONS D AND E ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
6. DIMENSIONS A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
7. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

| DIM | MILLIMETERS | | |
|-----|-------------|-------|-------|
| | MIN | NOM | MAX |
| A | 4.70 | 5.00 | 5.30 |
| A1 | 2.20 | 2.40 | 2.60 |
| A2 | 1.80 | 2.00 | 2.20 |
| b | 1.07 | 1.20 | 1.33 |
| b2 | 1.65 | 2.12 | 2.35 |
| b4 | 2.60 | 3.12 | 3.40 |
| c | 0.45 | 0.60 | 0.75 |
| D | 20.80 | 21.00 | 21.34 |
| D1 | 16.30 | --- | --- |
| D2 | 0.75 | --- | --- |
| E | 15.50 | 16.00 | 16.25 |
| E1 | 13.80 | --- | --- |
| E2 | 4.32 | 4.90 | 5.49 |
| e | 5.45 BSC | | |
| F | 2.655 | --- | --- |
| L | 19.80 | 20.00 | 20.80 |
| L1 | 3.81 | 4.20 | 4.35 |
| P | 3.55 | 3.60 | 3.65 |
| P1 | 6.60 | --- | --- |
| Q | 5.40 | 6.00 | 6.20 |
| S | 6.15 BSC | | |

GENERIC MARKING DIAGRAMS*



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

| | | |
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